

## **July 2011: Surface-Mount Technologies**

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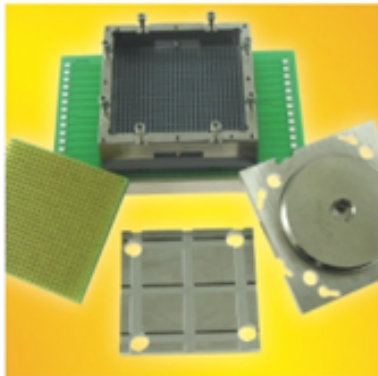


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This issue of ECN goes into surface-mount technologies including thermal management, an IC socket footprint, and boundary scan. Design Talk deals with open-air applications while Brainstorm discusses green technology in the military. Executive Editor Chris Warner also recaps his experience at the 2011 Sensors Expo.

Check it out [here](#) [1].

### Summary:

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